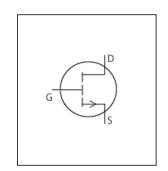


PSpice Model GaN Nexperia GAN140-650FBE



Model Information

Model A macro model based on BSIM3 model

Call Name MDC_GAN140-650FBE_PS

Pin Assign 1:D 2:G 3:S

File List Model Library MDC_GAN140-650FBE_PS01.lib

Model Report MDC_GAN140-650FBE_PS.pdf (this file)

Verified Simulator Version

Note

PSpice version 17.2

References

The information which was used for modeling is as follow:

[Data Sheet]

Date/Version
Product name
Company name
28 April 2023
GAN140-650FBE
Nexperia B.V.

Characteristics IdVds[Vgs],IdVds[Vgs]2,IdVgs[Temp],VthTemp[Id],IdVds[tem

p],NormRds(on)Temp[Vgs],Rds(on)Id[Vgs],Rds(on)Vgs[Id],Rds(on)Vgs[Id]2,VgsQg[Vdd],CapacitanceVds[Cname],IdVds[Vgs]3,IdVds[Vgs]4,IdVds[Vgs]5,IdVds[Vgs]6,SwitchingLload[

Tname], Switching Waveform

Simulation Range

This table shows the range of evaluated simulation range that was not occurs any convergence problems in this area.

| ltem | Range | | | Unit |
|---------------------------|-------|----|------|-------|
| | Min. | | Max. | |
| Drain-source voltage (DC) | 0 | to | 650 | V |
| Gate-source voltage (DC) | -1 | to | 7 | V |
| Temperature | -55 | to | 150 | deg C |



Model Functions Table

MOSFET

O: Implemented

×: Not Implemented

—: Not applicable

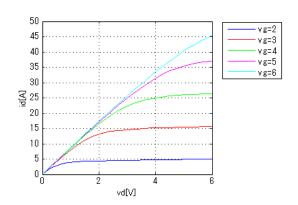
| n | Λ | J k | /_1 | |
|----|-----------|------------|--------------------|--|
| K, | ΑI | VΙΝ | $\setminus = \bot$ | |

| | KANK-1 | |
|------------------|--------|-------------|
| Functions | RANK | Implemented |
| ID-VDS-VGS | 1 | 0 |
| ID-VGS(Temp) | 1 | 0 |
| RDS(on) | 1 | 0 |
| Capacitance | 1 | 0 |
| Gate Charge | 1 | 0 |
| IS-VSD | 1 | 0 |
| Reverse recovery | 1 | _ |
| Switching(Typ.) | 1 | 0 |
| Bv | 1 | _ |
| Yfs | 1 | _ |
| Vth | 1 | 0 |



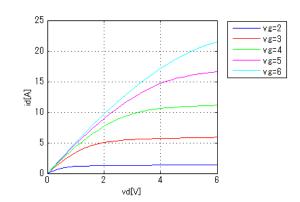
IdVds[Vgs]

Temp = 25degC



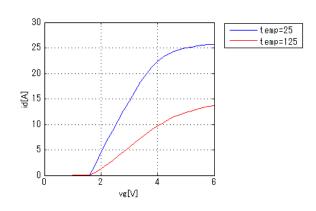
IdVds[Vgs]2

Temp = 125degC



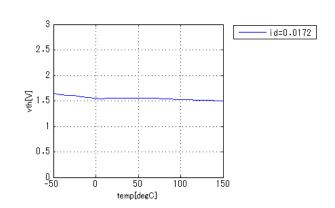
IdVgs[Temp]

Vds = 3V



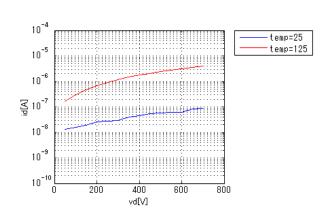
VthTemp[Id]

Vd = Vg



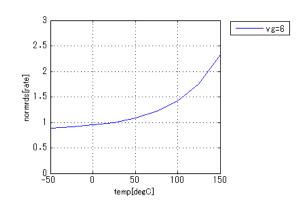
IdVds[temp]

vg = 0V



NormRds(on)Temp[Vgs]

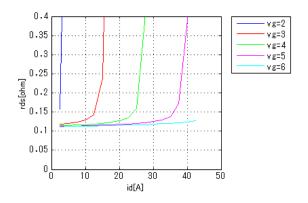
Id = 5A





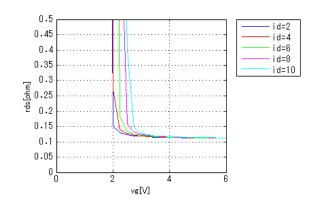
Rds(on)Id[Vgs]

Temp = 25degC



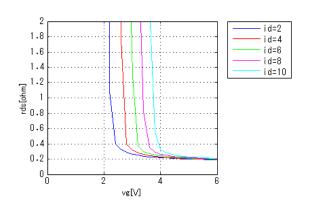
Rds(on)Vgs[Id]

Temp = 25degC



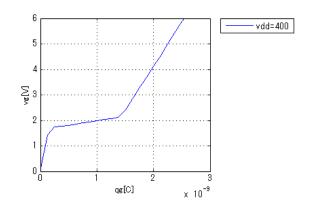
Rds(on)Vgs[Id]2

Temp = 125degC



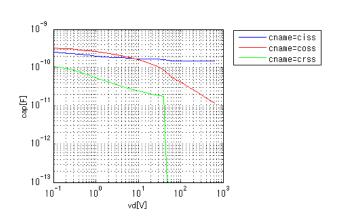
VgsQg[Vdd]

Id = 5A



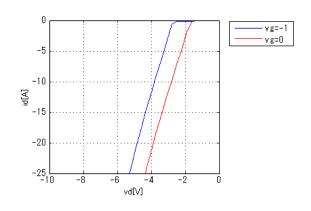
Capacitance Vds[Cname]

freq = 1000000Hz



IdVds[Vgs]3

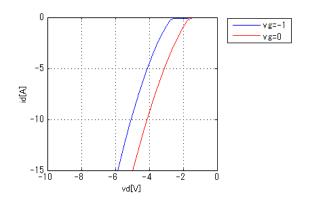
Temp = 25degC





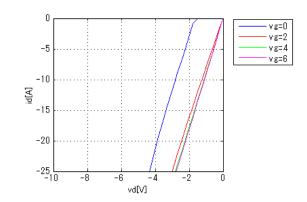
IdVds[Vgs]4

Temp = 125degC



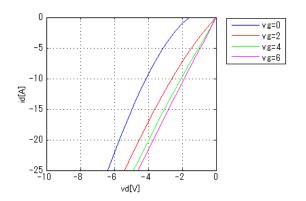
IdVds[Vgs]5

Temp = 25degC



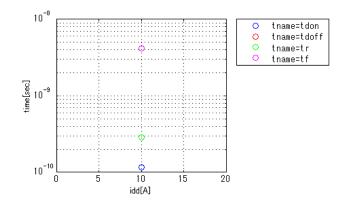
IdVds[Vgs]6

Temp = 125degC



SwitchingLload[Tname]

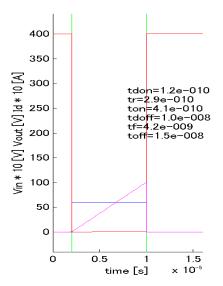
vgg = 6V, vdd = 400V, Lload = 0.000318H, RGon = 10ohm, RGon = 2ohm, Temp = 25degC

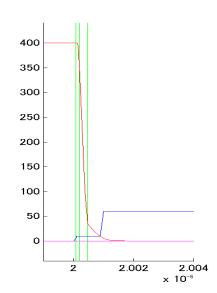


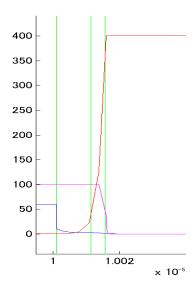


Switching Waveform (Blue: INPUT Red: OUTPUT Magenta: ID)

vgg = 6V, vdd = 400V, Lload = 0.000318H, RGon = 10ohm, RGon = 2ohm, Temp = 25degC, Id = 10A









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